PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT	
NATURE OF CONVEYANCE:	Corrective Assignment to correct the to remove incorrect serial number 12/896635 from the record previously recorded on Reel 027856 Frame 0597. Assignor(s) hereby confirms the Assignment of Assignors Interest.	

CONVEYING PARTY DATA

Name	Execution Date
Taiwan Semiconductor Manufacturing Company Ltd.	03/01/2012

RECEIVING PARTY DATA

Name:	TSMC Solid State Lighting Ltd.		
Street Address:	9, Li-Hsin 4th Road		
Internal Address:	Hsinchu Science Park		
City:	Hsinchu		
State/Country:	TAIWAN		
Postal Code:	300-77		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12189635

CORRESPONDENCE DATA

Fax Number: (214)200-0853 214-651-5000 Phone:

ipdocketing@haynesboone.com Email:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: Haynes and Boone, LLP Address Line 1: 2323 Victory Avenue

Address Line 2: Suite 700

Address Line 4: Dallas, TEXAS 75219

ATTORNEY DOCKET NUMBER:	48047.107/2008-0320
NAME OF SUBMITTER:	David M. O'Dell

PATENT REEL: 027876 FRAME: 0056

Total Attachments: 4

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PATENT REEL: 027876 FRAME: 0057

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
Taiwan Semiconductor Manufacturing Company Ltd.	03/01/2012

RECEIVING PARTY DATA

Name:	TSMC Solid State Lighting Ltd.		
Street Address:	9, Li-Hsin 4th Road		
Internal Address:	Hsinchu Science Park		
City:	Hsinchu		
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PROPERTY NUMBERS Total: 1

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Correspondent Name: Haynes and Boone, LLP 2323 Victory Avenue

Address Line 1: Address Line 2:

Suite 700

Address Line 4:

Dallas, TEXAS 75219

ATTORNEY DOCKET NUMBER:

2008-0320/48047.107

NAME OF SUBMITTER	₹:	David M. O'Dell
Signature:		/David M. O'Dell/
Date: 03/13/2012		
Total Attachments: 2 source=107Assignment#page1.tif source=107Assignment#page2.tif		
RECEIPT INFORMATION		
EPAS ID: Receipt Date:	PAT1885659 03/13/2012	
Fee Amount:	\$40	

ASSIGNMENT

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD., (hereinafter "ASSIGNOR"), of No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China, is the owner in the United States Patent and Trademark Office of the full and exclusive right, title and interest in and to the patent applications and patents for United States Patent and the inventions described therein on Attachment A.

WHEREAS, TSMC SOLID STATE LIGHTING LTD., (hereinafter "ASSIGNEE"), of 9, Li-Hsin 4th Road, Hsinchu Science Park, Hsinchu, Taiwan 300-77, is desirous of acquiring the entire right, title, and interest in, and to said listed patent applications and patents, said inventions and any patents that may issue on said applications within the United States of America and its territorial possessions;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and ASSIGNOR hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND ASSIGNOR HEREBY covenant that ASSIGNOR have full right to convey the entire interest herein assigned, and that ASSIGNOR have not executed, and will not execute, any agreement in conflict herewith.

AND ASSIGNOR HEREBY further covenant and agree that ASSIGNOR will communicate to said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

TAIWAN SEMICONDUCTOR MANUECT PRINT COMPANY, LTD.

Director, IP Division

Title

301 2012

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Assignment

ATTACHMENT A

TSMC Ref. No.	Attorney Reference No	Ctry / Region	Application No.	Filing Date	Title
2008-0320	48047.107	US	12/189635	11-Aug-2008	Light-Emitting Diode with Textured Substrate

R-107Assignment TSMC to TSSL.doc

RECORDED: 03/16/2012

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